

# **TIP29 Series(TIP29/29A/29B/29C)**

## **Medium Power Linear Switching Applications**

• Complementary to TIP30/30A/30B/30C



### 1.Base 2.Collector 3.Emitter

## **NPN Epitaxial Silicon Transistor**

## Absolute Maximum Ratings T<sub>C</sub>=25°C unless otherwise noted

Symbol	Parameter	Value	Units
$V_{CBO}$	Collector-Base Voltage : TIP29	40	V
	: TIP29A	60	V
	: TIP29B	80	V
	: TIP29C	100	V
V <sub>CEO</sub>	Collector-Emitter Voltage : TIP29	40	V
	: TIP29A	60	V
	: TIP29B	80	V
	: TIP29C	100	V
V <sub>EBO</sub>	Emitter-Base Voltage	5	V
I <sub>C</sub>	Collector Current (DC)	1	Α
I <sub>CP</sub>	Collector Current (Pulse)	3	А
I <sub>B</sub>	Base Current	0.4	А
P <sub>C</sub>	Collector Dissipation (T <sub>C</sub> =25°C)	30	W
	Collector Dissipation (T <sub>a</sub> =25°C)	2	W
T <sub>J</sub>	Junction Temperature	150	°C
T <sub>STG</sub>	Storage Temperature	- 65 ~ 150	°C

### Electrical Characteristics T<sub>C</sub>=25°C unless otherwise noted

Symbol	Parameter	Test Condition	Min.	Max.	Units
V <sub>CEO</sub> (sus)	*Collector-Emitter Sustaining Voltage				
	: TIP29	$I_C = 30 \text{mA}, I_B = 0$	40		V
	: TIP29A		60		V
	: TIP29B		80		V
	: TIP29C		100		V
I <sub>CEO</sub>	Collector Cut-off Current				
	: TIP29/29A	$V_{CE} = 30V, I_{B} = 0$		0.3	mA
	: TIP29B/29C	$V_{CE} = 60V, I_{B} = 0$		0.3	mA
I <sub>CES</sub>	Collector Cut-off Current				
	: TIP29	$V_{CE} = 40V, V_{EB} = 0$		200	μΑ
	: TIP29A	$V_{CE} = 60V, V_{EB} = 0$		200	μΑ
	: TIP29B	$V_{CE} = 80V, V_{EB} = 0$		200	μΑ
	: TIP29C	$V_{CE} = 100V, V_{EB} = 0$		200	μΑ
I <sub>EBO</sub>	Emitter Cut-off Current	$V_{EB} = 5V, I_{C} = 0$		1.0	mA
h <sub>FE</sub>	*DC Current Gain	$V_{CE} = 4V, I_{C} = 0.2A$	40		
		$V_{CE} = 4V, I_{C} = 1A$	15	75	
V <sub>CE</sub> (sat)	*Collector-Emitter Saturation Voltage	I <sub>C</sub> = 1A, I <sub>B</sub> = 125mA		0.7	V
V <sub>BE</sub> (sat)	*Base-Emitter Saturation Voltage	$V_{CE} = 4V, I_{C} = 1A$		1.3	V
f <sub>T</sub>	Current Gain Bandwidth Product	V <sub>CE</sub> = 10V, I <sub>C</sub> = 200mA	3.0		MHz
Pulse Test: PW≤3	00μs, Duty Cycle≤2%		•	•	•

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# **Typical Characteristics**

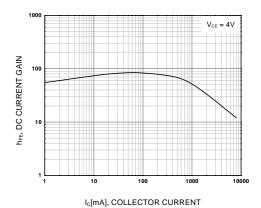


Figure 1. DC current Gain

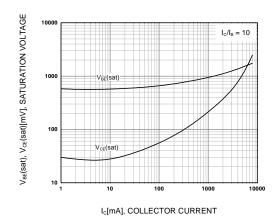


Figure 2. Base-Emitter Saturation Voltage Collector-Emitter Saturation Voltage

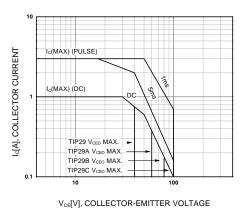


Figure 3. Safe Operating Area

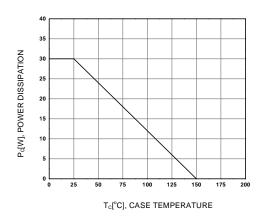
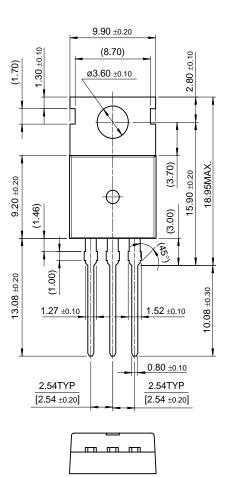


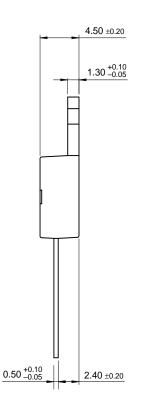
Figure 4. Power Derating

# **Package Demensions**

TO-220



10.00 ±0.20



Dimensions in Millimeters

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